# imall

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#### Description

The 4942–4944 *Sn100e Lead Free RA Solder* is an electronic grade solder wire. It uses a high-purity, eutectic tin/copper/cobalt alloy that exceeds J-STD-006 purity specifications. It is complemented with a rosin activated, medium activity flux that is classified as ROM1 according to J-STD-004B.

This solder is a great lead-free alternative to leaded solders. It generally provides better wetting, contact angle, flow, and visual appearance than typical Sn63/Pb37 no clean solders, while still delivering excellent performance characteristics. It offers superior solder penetration into plated through holes and surface mount interconnects. Further, it is a suitable replacement for SAC305 solder since the 494x forms brighter, shinier, and less grainy joints. Furthermore, it is less expensive than SAC305.

The 4942–4944 solders achieve a consistent solder and flux percentage through a state-of-the-art, extrusion, wire-drawing machine. This machine continually monitors the wire to prevent voids and ensure consistency, providing a top-grade solder wire.

#### **Benefits & Features**

- Lead free eutectic alloy (liquidus = solidus temperature)
- Exceeds J-STD-006 impurity requirements
- Fast wetting
- Fast flowing
- Non-corrosive
- Non-conductive residues

# Wire Sizes Availability

#### COMPLIANCE

- ✓ Dobb Frank (<u>DRC conflict free</u>)
- ✓ REACH (<u>compliant</u>)
- ✓ RoHS (<u>compliant</u>)

Cat No.	<i>Std. Wire</i> <i>Gauge</i>	Diameter		Packaging	Sizes
4942	21	0.81 mm	0.032 in	Spool	¼ or 1 lb
4944	25	0.51 mm	0.020 in	Spool	¼ or 1 lb

#### **General Flux Parameters**

Properties	Value
Residue Removal	Not required
Flux Percentage	2.2%
Flux feature	Fast wetting, fast flowing, non-conductive
Shelf life	5 y

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#### **Flux Core Properties**

The rosin activated flux wets rapidly and is fast flowing. It is also non-conductive and non-corrosive.

Physical Properties	Method	Value
Flux Classification	J-STD-004	ROM1
	MIL-F-14256F	RA
Flux Type		Rosin
%Halides		0.5–2.0%
Color		Amber solid
Softening Point of Flux Extract		80 °C [176 °F]
Acid Number (mgKOH/g sample)	IPC-TM-650 2.3.13	150-160
Silver Chromate—Chlorides + Bromides	IPC-TM-650 2.3.33	Detection
Surface Insulation Resistance (SIR)	IPC-TM-650 2.6.3.3	$> 1.0 \times 10^{9} \Omega$
Corrosion Test	IPC-TM-650 2.6.15	Non-corrosive
Cleaning Requirements	-	Application dependent <sup>a)</sup>

a) Since there is only 2.2% flux, removal of residue can be considered optional for some applications.

## **Sn100e Alloy Typical Literature Properties**

Physical Properties	Value <sup>a)</sup>	
Color	Silvery-white metal	
Density @26 °C [78 °F]	7.4 g/cm <sup>3</sup>	
Tensile Strength Elongation	28 N/mm <sup>2</sup> [4 100 lb/in <sup>2</sup> ] 27%	
Shear Strength	~20 N/mm <sup>2</sup> [~2 900 lb/in <sup>2</sup> ]	
Electrical Properties	Value	
Volume Resistivity	12.3 μΩ·cm	
Electrical Conductivity <sup>b</sup>	15% IACS	

a) N/mm<sup>2</sup> = mPa; lb/in<sup>2</sup> = psi;

b) International Annealed Copper Standard: 100% give 5.8  $\times$  10  $^7$  S/m.

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Thermal Properties	Value
Melting Point, Solidus	228 °C [442 °F]
Melting Point, Liquidus	228 °C [442 °F]
Tip Temperature Upper Limit	Do not exceed 425 °C [800 °F]
Coefficient of Thermal Expansion (CTE) <sup>c)</sup>	23.5 ppm/°C
Thermal Conductivity	82 W/(m·K)
Specific Heat Capacity	294 J/(kg·K)

*NOTE:* This table present typical literature values for Sn99.5/Cu0.5/Co alloys. c) CTE for pure tin; unit conversions: ppm/°C =  $\mu$ m/(m·K) = in/in/°C × 10<sup>-6</sup> = unit/unit/°C × 10<sup>-6</sup>

## **Solder Alloy Composition**

Properties	Value	Properties	J-STD-006C	4942-4944 Values
MAIN INGREDIENTS Sn	<i>COMPOSITION</i> 99.3 to 99.7%	IMPURITIES <sup>a)</sup> Sb	REQUIREMENTS ≤0.20% Max	SPECIFICATIONS ≤0.025% Max
Cu	0.49 to 0.51%	Ag	≤0.10% Max	≤0.001% Max
Со	<0.1%	Bi	≤0.10% Max	≤0.01% Max
		In	≤0.10% Max	≤0.01% Max
COMPLIANT		Pb	≤0.07% Max	≤0.05% Max
		Au	≤0.05% Max	≤0.0002% Max
		As	≤0.05% Max	≤0.0035% Max
		Fe	≤0.02% Max	≤0.005% Max
		Ni	≤0.01% Max	≤0.006% Max
		Al	≤0.005% Max	≤0.001% Max
		Zn	≤0.003% Max	≤0.001% Max
		Cd	≤0.002% Max	≤0.001% Max

a) Meets the requirements of J-STD-006

#### Storage

Protect from direct heat or sunlight. Store between 18 to 27 °C [65 to 80 °F].

#### Cleaning

The flux residue does not need to be removed for typical applications. If removal is desired, a solvent system like the *MG 4140* can be used. For best results, warm the cleaning solution to about 40 °C [104 °F].



#### Health and Safety

Please see the 4942-4944 **Safety Data Sheet** (SDS) for more details on transportation, storage, handling and other security guidelines.

Health and Safety: Avoid breathing fumes. Wash hands thoroughly after use. Do not ingest.

#### HMIS® RATING

HEALTH:	*	1
FLAMMABILITY:		0
PHYSICAL HAZARD:		0
PERSONAL PROTECTION:		

NFPA® 704 CODES



Approximate HMIS and NFPA Risk Ratings Legend: 0 (Low or none); 1 (Slight); 2 (Moderate); 3 (Serious); 4 (Severe)

#### **Soldering Instructions**

#### To achieve best hand-soldering results

- 1. Set the tip temperature between 370-425 °C [700-800 °F].
- Place the solder tip in contact with the joint connection (lead/pad surface) at an angle of around 50° to heat the parts to be soldered.
- 3. While the soldering tip is applied, touch the solder wire to the opposite side of the soldering joint, not to the soldering tip.
- 4. Immediately after the solder has flowed around the whole heated connection, remove the solder wire and remove soldering tip from connection.

**TIP!** Do not move the connection while the solder is cooling.

**WARNING!** Avoid putting too much or too little solder.

**ATTENTION!** To avoid damage, do not overheat electrical component.

#### **Packaging and Supporting Products**

Cat. No.	Form	Packaging	Net Weight	
4942-112G	Solid wire	Spool	112 g	0.25 lb
4942-454G	Solid wire	Spool	454 g	1.0 lb
4944-112G	Solid wire	Spool	112 g	0.25 lb
4944-454G	Solid wire	Spool	454 g	1.0 lb



### **Technical Support**

Contact us regarding any questions, improvement suggestions, or problems with this product. Application notes, instructions, and FAQs are located at <u>www.mgchemicals.com</u>.

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#### Warranty

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